

F640NL-VB Datasheet N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
200	$0.038 \text{ at V}_{GS} = 15 \text{ V}$	45	57		
200	0.043 at V _{GS} = 10 V	40	57		

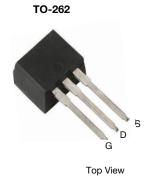
FEATURES

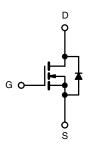
- Trench Power MOSFETS
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested



APPLICATIONS

- Power Supply
- Lighting Systems





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}C$, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	200	V	
Gate-Source Voltage	V _{GS}	± 25	v	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	L	45	
	T _C = 100 °C	l _D	26	^
Pulsed Drain Current		I _{DM}	150	— A
Single Pulse Avalanche Current	urrent L = 0.1 mH		20	
Single Pulse Avalanche Energy ^a	L = 0.111111	E _{AS}	20	mJ
	T _C = 25 °C	В	166 ^b	14/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	P _D	3.12	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W
Junction-to-Case (Drain)	R _{thJC}	0.75	C/VV

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	V	
Coto Podella della	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 300		
		V _{DS} = 200 V, V _{GS} = 0 V			1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$			25		
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.038			
Drain Course On State Besistance	B	$V_{GS} = 15 \text{ V}, I_D = 20 \text{ A}$		0.043			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 100 °C		0.088		Ω	
		V _{GS} = 10 V, I _D = 20 A, T _J = 150 °C		0.120			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S	
Dynamie th							
Input Capacitance	C _{iss}			3100		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		300			
Reverse Transfer Capacitance	C _{rss}			135			
Total Cata Charge ^C	Qg	$V_{DS} = 100 \text{ V}, V_{GS} = 15 \text{ V}, I_D = 50 \text{ A}$		85	127		
Total Gate Charge ^c				57	85	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		14		110	
Gate-Drain Charge ^c	Q_{gd}			20			
Gate Resistance	R_{g}	f = 1 MHz		1.2	1.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			16	25		
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 2 Ω		170	260	nc	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		27	42	ns	
Fall Time ^c	t _f			9	18	1	
Source Drain Diord Harings Sanct Cha	Pagrépréstég st	- _{CC} = 25 25CC					
Continuous Current	I _S				36		
Pulsed Current	I _{SM}				80	Α	
Forward Voltage ^a	V _{SD}	I _F = 20 A, V _{GS} = 0 V		0.86	1.5	V	
Reverse Recovery Time	t _{rr}			116	175	ns	
Peak Reverse Recovery Current	I _{RM(REC)}			9	14	Α	
Reverse Recovery Charge	Q _{rr}	$I_F = 40 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		0.53	0.8	μС	
Reverse Recovery Fall Time	t _a	·		84			
Reverse Recovery Rise Time	t _b			32		nS	

Notes:

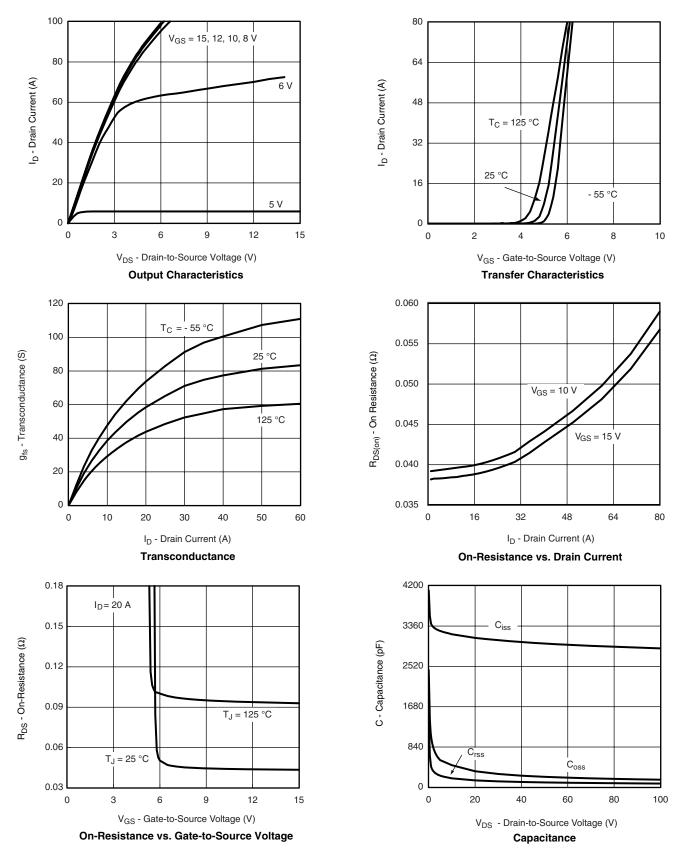
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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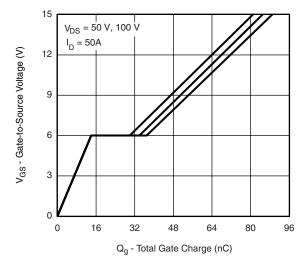


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

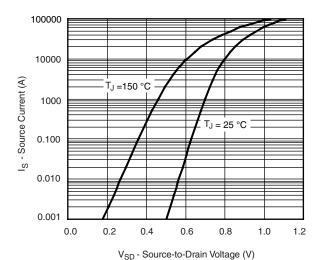




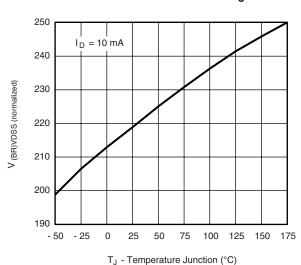
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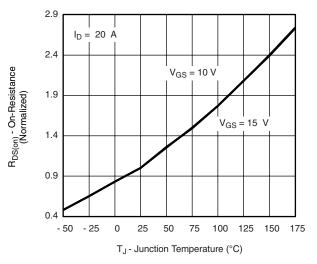




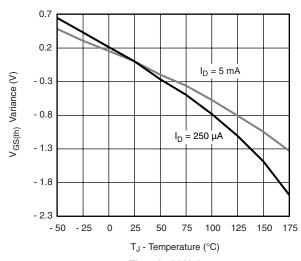
Source-Drain Diode Forward Voltage



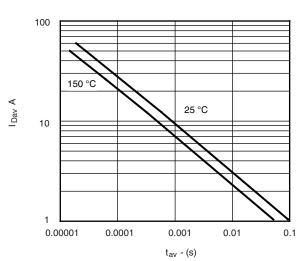
Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Junction Temperature



Threshold Voltage



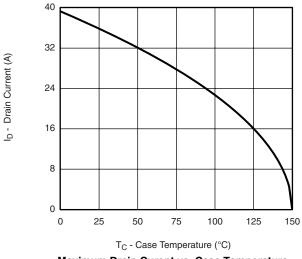
Single Pulse Avalanche Current Capability vs. Time

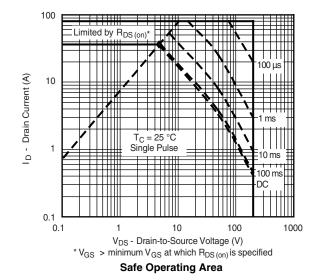
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Normalized Effective Transient Thermal Impedance

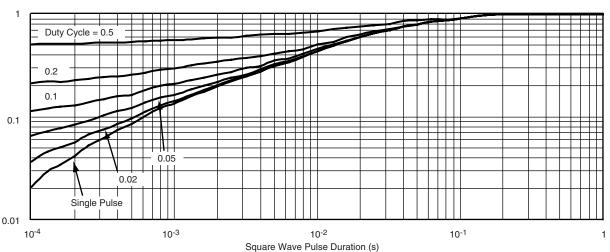


THERMAL RATINGS





Maximum Drain Curent vs. Case Temperature



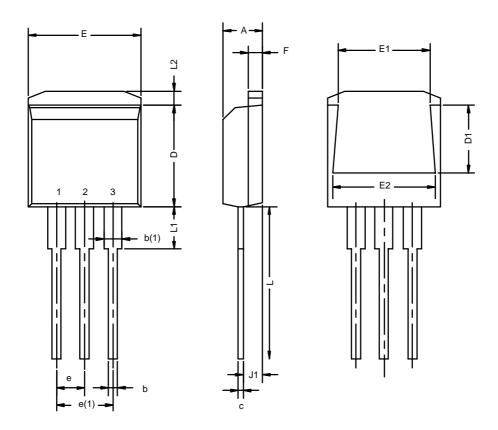
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-262: 3-LEAD



	MILLIMETERS* INCHES			HES	
Dim	Min	Max	Min	Max	
Α	4.32	4.70	0.170	0.185	
b	0.64	1.00	0.025	0.039	
b(1)	1.14	1.40	0.045	0.055	
С	0.36	0.50	0.014	0.020	
D	8.64	9.65	0.340	0.380	
D1	5.59	6.10	0.220	0.240	
е	2.41	2.67	0.095	0.105	
e(1)	4.95	5.33	0.195	0.210	
Е	10.03	10.41	0.395	0.410	
E1	7.87	8.64	0.310	0.340	
E2	9.02	9.53	0.355	0.375	
F	1.14	1.40	0.045	0.055	
J1	2.41	2.79	0.095	0.110	
L	13.08	14.22	0.515	0.560	
L1	-	3.81	-	0.150	
L2	1.02	1.40	0.040	0.055	
ECN: T-02234—Rev. C, 14-Oct-02 DWG: 5855					

^{*}Use millimeters as the primary measurement

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